

NCE Automotive P-Channel Enhancement Mode Power MOSFET

Description

The NCEA01P13K uses advanced trench technology and design to provide excellent $R_{DS(ON)}$ with low gate charge. It can be used in a wide variety of applications. It is ESD protested.

General Features

• V_{DS} =-100V,I_D =-13A

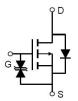
 $R_{DS(ON)}\,{<}200m\Omega\;\textcircled{0}\;V_{GS}{=}{-}10V\quad (Typ:170m\Omega)$

 $R_{DS(ON)}$ <240m Ω @ V_{GS} =-4.5V (Typ:184m Ω)

- High density cell design for ultra low Rdson
- Fully characterized avalanche voltage and current
- Good stability and uniformity with high EAS
- Excellent package for good heat dissipation
- •175 °C operating temperature
- Pb-free lead plating; RoHS compliant
- Halogen-free according to IEC61249-2-21
- 100% UIS tested
- 100% ΔVds tested
- AEC-Q101 qualified

Application

- Automotive application
- High side switch for full bridge converter
- DC/DC converter for LCD display



Schematic diagram



Marking and pin assignment



TO-252-2L top view

Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
A01P13K	NCEA01P13K	TO-252-2L	Ø330mm	16mm	2500 units

Absolute Maximum Ratings (T_C=25℃unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	V _{DS}	-100	V
Gate-Source Voltage	Vgs	±20	V
Drain Current-Continuous	I _D	-13	Α
Drain Current-Continuous(T _C =100℃)	I _D (100°C)	-9.2	А
Pulsed Drain Current	I _{DM}	-52	Α
Maximum Power Dissipation	P _D	73	W
Derating factor		0.49	W/℃
Single pulse avalanche energy (Note 5)	E _{AS}	110	mJ
Operating Junction and Storage Temperature Range	T_{J}, T_{STG}	-55 To 175	$^{\circ}$

Thermal Characteristic

Thermal Resistance, Junction-to-Case (Note 2)	R _{θJc}	2.05	°C/W



Electrical Characteristics (T_C=25[°]Cunless otherwise noted)

Parameter	Symbol	Condition	Min		Max	Unit	
Off Characteristics							
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =-250µA	-100	-	-	V	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =-100V,V _{GS} =0V	-	-	1	μΑ	
Gate-Body Leakage Current	I _{GSS}	V _{GS} =±20V,V _{DS} =0V	-	-	±10	μA	
On Characteristics (Note 3)	,						
Gate Threshold Voltage	V _{GS(th)}	V _{DS} =V _{GS} ,I _D =-250μA	-1	-1.9	-3	V	
D : 0		V _{GS} =-10V, I _D =-10A	-	170	200	mΩ	
Drain-Source On-State Resistance	R _{DS(ON)}	V _{GS} =-4.5V, I _D =-10A	-	184	240		
Forward Transconductance	g FS	V _{DS} =-5V,I _D =-10A	12	-	-	s	
Dynamic Characteristics (Note4)	1					1	
Input Capacitance	Clss		-	1492	-	PF	
Output Capacitance	Coss	V _{DS} =-50V,V _{GS} =0V,	-	44	-	PF	
Reverse Transfer Capacitance	C _{rss}	F=1.0MHz	-	42	-	PF	
Switching Characteristics (Note 4)	1						
Turn-on Delay Time	t _{d(on)}		-	12	-	nS	
Turn-on Rise Time	tr	V _{DD} =-50V,I _D =-10A	-	52	-	nS	
Turn-Off Delay Time	$t_{d(off)}$	V_{GS} =-10V, R_{GEN} =9.1 Ω	-	28	-	nS	
Turn-Off Fall Time	t _f		-	38	-	nS	
Total Gate Charge	Qg	.,,,	-	32	-	nC	
Gate-Source Charge	Q _{gs}	V _{DS} =-50V,I _D =-10A,	-	5	-	nC	
Gate-Drain Charge	Q _{gd}	V _{GS} =-10V	-	7	-	nC	
Drain-Source Diode Characteristics	1						
Diode Forward Voltage (Note 3)	V _{SD}	V _{GS} =0V,I _S =-10A	-	-	-1.2	V	
Diode Forward Current (Note 2)	Is	-	-	-	-13	Α	
Reverse Recovery Time	t _{rr}	TJ = 25°C, IF =-10A	-	35	-	nS	
Reverse Recovery Charge	Qrr	di/dt = 100A/µs ^(Note3)	-	46	-	nC	
Forward Turn-On Time	t _{on}	Intrinsic turn-on time is negligible (turn-on is dominated by LS+LI					

Notes:

- 1. Repetitive Rating: Pulse width limited by maximum junction temperature.
- 2. Surface Mounted on FR4 Board, t ≤ 10 sec.
- 3. Pulse Test: Pulse Width ≤ 300µs, Duty Cycle ≤ 2%.
- 4. Guaranteed by design, not subject to production
- **5.** E_{AS} condition: Tj=25 $^{\circ}\text{C}$,V_{DD}=-50V,V_G=-10V,L=0.5mH,Rg=25 Ω



Typical Electrical and Thermal Characteristics (Curves)

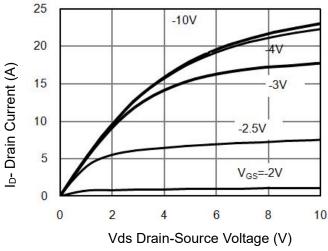


Figure 1 Output Characteristics

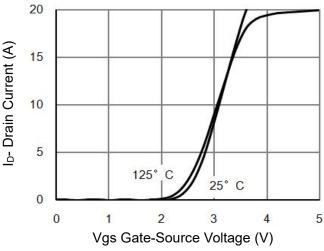


Figure 2 Transfer Characteristics

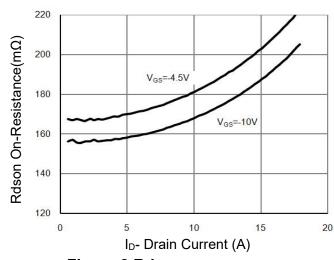


Figure 3 Rdson- Drain Current

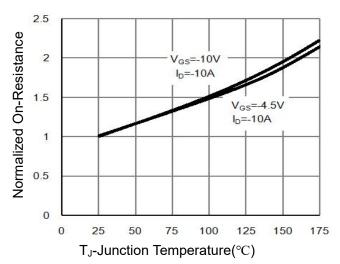


Figure 4 Rdson-JunctionTemperature

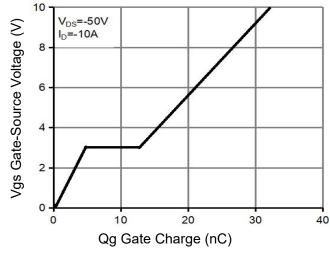


Figure 5 Gate Charge

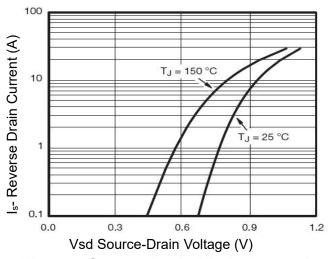
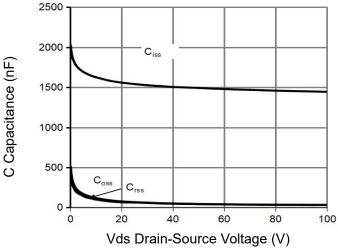


Figure 6 Source- Drain Diode Forward





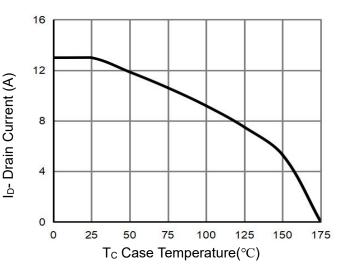
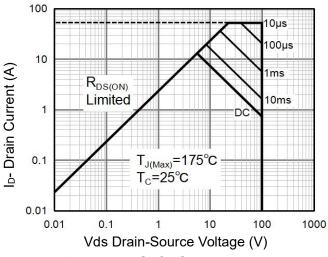


Figure 7 Capacitance vs Vds

Figure 9 Drain Current vs Case Temperature



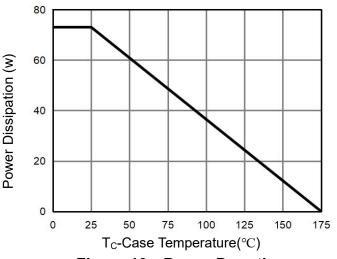


Figure 8 Safe Operation Area

Figure 10 Power De-rating

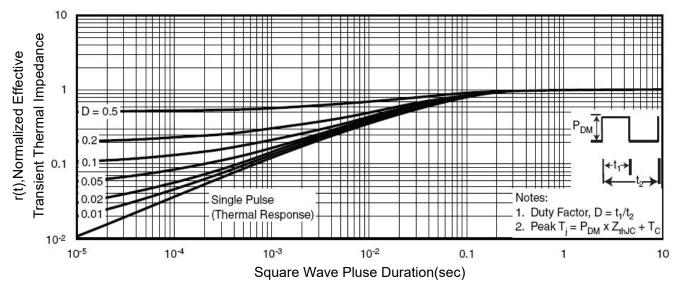
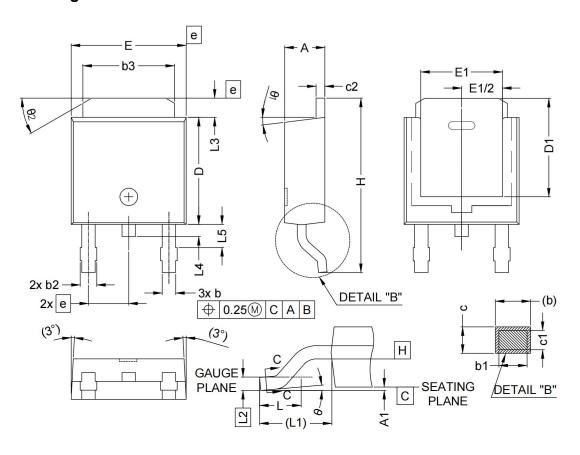


Figure 11 Normalized Maximum Transient Thermal Impedance



TO-252-2L Package Information



SYMBOL	MIN.	MAX.	SYMBOL	MIN.	MAX.	SYMBOL	MIN.	MAX.
A	2.18	2.39	E	6.35	6.73	θ1	0°	15°
A1	-	0.13	E1	4.32	1.1=	θ2	25°	35°
b	0.65	0.89	е	2.29 BSC				
b1	0.64	0.79	Н	9.94	10.34			
b2	0.76	1.13	L	1.50	1.78			
b3	4.95	5.46	L1	2.74 REF				
c	0.46	0.61	L2	0.51 BSC				
c1	0.41	0.56	L3	0.89	1.27			
c2	0.46	0.60	L4	-	1.02			
D	5.97	6.22	L5	1.14	1.49			
D1	5.21	-	θ	0°	10°			

NOTE; 1.0 DIMENSIONING & TOLERANCEING CONFIRM TO ASME Y14.5M-1994.

2.0 ALL DIMENSIONS ARE IN MILLIMETERS. ANGLES ARE IN DEGREES. 3.0 HEAT SINK SIDE FLASH IS MAX. 0.8mm.

4.0 RADIUS ON TERMINAL IS OPTIONAL.



Attention:

- Any and all NCE power products described or contained herein do not have specifications that can handle applications that require extremely high levels of reliability, such as life-support systems, aircraft's control systems, or other applications whose failure can be reasonably expected to result in serious physical and/or material damage. Consult with your NCE power representative nearest you before using any NCE power products described or contained herein in such applications.
- NCE power assumes no responsibility for equipment failures that result from using products at values that exceed, even momentarily, rated values (such as maximum ratings, operating condition ranges, or other parameters) listed in products specifications of any and all NCE power products described or contained herein.
- Specifications of any and all NCE power products described or contained herein stipulate the performance, characteristics, and functions of the described products in the independent state, and are not guarantees of the performance, characteristics, and functions of the described products as mounted in the customer's products or equipment. To verify symptoms and states that cannot be evaluated in an independent device, the customer should always evaluate and test devices mounted in the customer's products or equipment.
- NCE power CO.,LTD. strives to supply high-quality high-reliability products. However, any and all semiconductor products fail with some probability. It is possible that these probabilistic failures could give rise to accidents or events that could endanger human lives, that could give rise to smoke or fire, or that could cause damage to other property. When designing equipment, adopt safety measures so that these kinds of accidents or events cannot occur. Such measures include but are not limited to protective circuits and error prevention circuits for safe design, redundant design, and structural design.
- In the event that any or all NCE power products (including technical data, services) described or contained herein are controlled under any of applicable local export control laws and regulations, such products must not be exported without obtaining the export license from the authorities concerned in accordance with the above law.
- No part of this publication may be reproduced or transmitted in any form or by any means, electronic or mechanical, including photocopying and recording, or any information storage or retrieval system, or otherwise, without the prior written permission of NCE power CO.,LTD.
- Information (including circuit diagrams and circuit parameters) herein is for example only; it is not guaranteed for volume production. NCE power believes information herein is accurate and reliable, but no guarantees are made or implied regarding its use or any infringements of intellectual property rights or other rights of third parties.
- Any and all information described or contained herein are subject to change without notice due to product/technology improvement, etc. When designing equipment, refer to the "Delivery Specification" for the NCE power product that you intend to use.
- This catalog provides information as of Apr.2023. Specifications and information herein are subject to change without notice.